Features

- 3-Way Active Splitter
- Single Ended Input and Outputs
- Gain 3.1dB @ 50MHz
- 15dBmV / Channel Input
- NF 3.4dB @ 400MHz
- Lead-free / Green / RoHS♥ compliant DFN Package

Applications

- Set-top Box
- Home Gateways
- CATV Distribution System
- Cable Splitter Modules

Functional Diagram

RF IN		5	RFO		3
Feedback/bias 4 RFOUT2 1					•
			RF 0	013	8
OUT2 N/C	• 1 2			8	OUT3 N/C
OUT1	3		7	6	N/C
FB	4			-5	IN

Exposed Pad – RF/DC GND

* The exposed pad centered on the package bottom must be connected to RF/DC ground.

ESD/MSL

- 1 ESD sensitive device. Observe handling precautions.
- 2 HBM: Class 1B, JESD22-A114
- 3 CDM: Class C3 , JESD22-C101F
- 4 MSL 3, J-STD-020

Description

The PSC13A is a GaAs MMIC single ended 3-way active splitter which exhibits low noise figure and distortion in a lead-free 2mm 8-lead DFN plastic package. The device features 75Ω input and outputs. The PSC13A is fabricated in using p-HEMT process to realize low noise and low distortion. All devices are 100% RF and DC tested.

Specifications

Units	Тур.	Condition
dB	3.1	IN to OUT1/OUT2/OUT3
dB	0.7	IN to OUT1/OUT2/OUT3
dB	19	IN
dB	9.6	OUT1/OUT2/OUT3
dB	30	OUT1/OUT2/OUT3 to IN
dB	24	Isolation between all RF Outputs
dB	3.4	IN to OUT1/OUT2/OUT3
dBc	-59	132ch, 15 dBmV/channel at the Input
dBc	-59	132ch, 15dBmV/channel at the Input
dBm	8	IN to OUT1/OUT2/OUT3
dBm	23	@ 500MHz, Note 1 ²⁾
mA	130	
V	5	
°C	22	@Tc=85℃
	dB dB dB dB dB dB dB dBc dBc dBc dBm dBm dBm v	dB 3.1 dB 0.7 dB 19 dB 19 dB 9.6 dB 30 dB 24 dB 3.4 dBc -59 dBc -59 dBm 8 dBm 23 mA 130

1) Test Conditions : T=25°C, Supply Voltage=5V, 75ohm System,

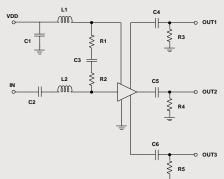
2) Note 1. OIP3 measured with two tones at an output power of -15dBm/tone separated by 6MHz.

Absolute Maximum Ratings

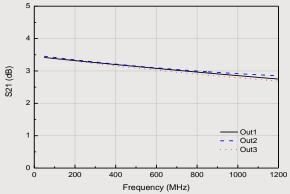
Parameter	Rating	Unit
Device Voltage	10	V
RF Power Input	12	dBm
Storage Temperature	-55 to 150	°C
Ambient Operating Temperature	-40 to 85	°C
Junction Temperature	185	°C

Stresses above the maximum values listed have may cause permanent damage to the device.
MTTF is more than 100 years.

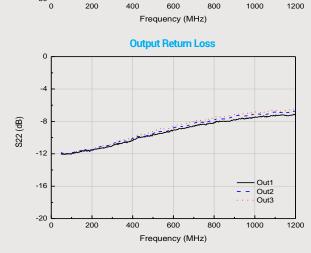
RF Application Circuit





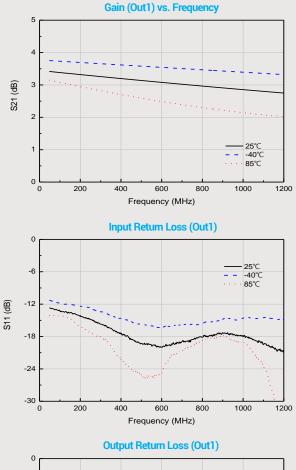


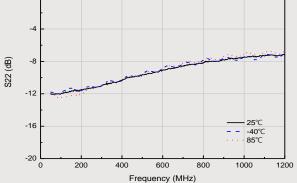




Component Values of Application Circuit

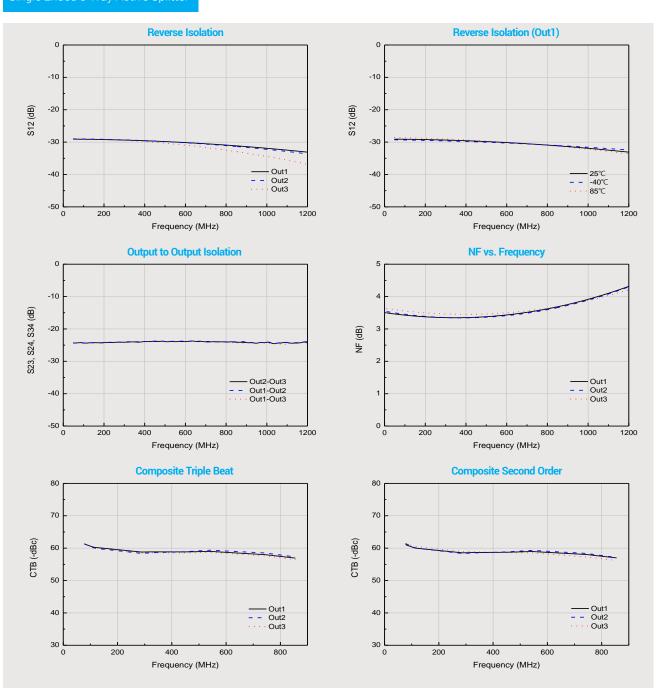
Component	Value	Remark
C1, C2, C3, C4, C5, C6	0.01uF	
L1	1uH	1210 package
L2	5.1nH	
R1, R2	180Ω	
R3, R4, R5	390Ω	

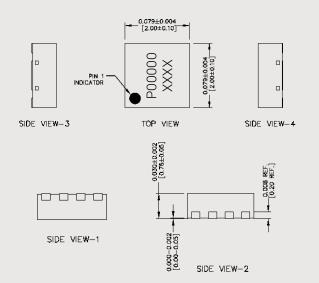




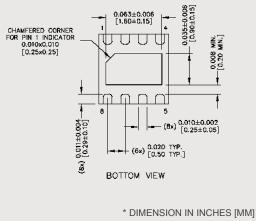
S11 (dB)

-30

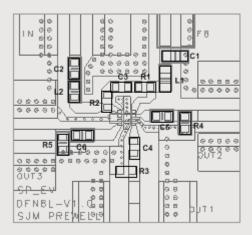




Lead-free /RoHS Compliant / Green 2x2 DFN 8L Package Outline



Evaluation Board Layout (27 x 25)



Mounting Instructions

- 1 Use a large ground pad area with many plated through-holes as shown.
- 2 We recommend 1 oz copper minimum.
- 3 Measurement for our data sheet was made on 1.6mm thick FR-4 Board.
- 4 RF trace width depends on the board material and construction.
- 5 Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.